



Product Change Notification

Product Change Notification Number: CC095002

Date: December 20, 2009

Title: Qualify Grinding and Dicing Services Inc. (GDSI) for ASIC Military Wafer Product Backgrind Operation

Product Identification:

All wafer, die, and package combinations of Atmel devices identified in Attachment A.

Reason for Change:

☐ Design

☒ Manufacturing Location

☐ Processing

☐ Quality/Reliability

☐ Logistics

☐ Material

Change Description:

Qualify Grinding and Dicing Services Inc. (GDSI) as second source for backgrind of military wafers.

Identification Method to Distinguish Change:

The transfer of the grind operation from Colorado Springs to GDSI will be transparent. Lots will be internally documented.

Qualification Data:

☒ available

☐ will be available in WW__

☐ not applicable

Samples:

☐ available

☐ will be available in WW__

☒ not applicable

Quantifiable Impact on Quality & Reliability:

No impact

Proposed First Ship Date*:

March 18, 2010

**The Proposed First Ship Date is the forecasted date that a customer may expect to receive changed product. This is determined by the estimated date of inventory depletion on the PCN issue date. This may be affected by fluctuations in supply and demand. Consequently, although customers should be prepared to receive changed product on this date, Atmel will continue to ship pre-changed product until a time in which inventory has been depleted. This may result in pre-changed product being shipped to customers after this forecasted date.*

Atmel Contact: pcnadm@atmel.com

Atmel will deem this change accepted unless specific conditions of acceptance are provided in writing within 30 days from the date of this notice. All correspondence must be sent to the Atmel Contact e-mail address listed above.

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Attachment A

Device Number
81000105
81000702
81000703
81000704
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81000707
81000708
81000709
81000713
81000716
81000728
81000901
81001300
81002808
81004803
82000859
82000955
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82001382
82001651
82001752
82008014
AT8356818
AT8356C05
AT8356C37
AT8356J06
AT8356J07
AT8357210
AT8357217
AT8357218
AT8357223